

10007457-1

**IN THE UNITED STATES  
PATENT AND TRADEMARK OFFICE**

5 **Inventors:** Jeffrey S. Obert, et al. **Examiner:** S. Ahmed  
**Serial No:** 09/888,975 **Group Art Unit:** 1765  
**Filing Date:** June 22, 2001 **Confirmation No:** 9544  
**Title:** Slotted Substrate And Slotting Process

10 **To:** Commissioner of Patents and Trademarks  
PO Box 1450  
Alexandria, VA 22313-1450

15 **From:** Robert Sismilich  
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**AMENDMENT**

20 In response to the "Notice of Non-Compliant Amendment" dated  
September 9, 2003, a compliant "Amendments to the Claims" section is hereby  
submitted to replace the non-compliant section.